

WHAT IS CLAIMED IS:

1. A printed circuit board having circuit patterns printed thereon comprising a plurality of composite lands each including a first land having a terminal hole made at its center for inserting the terminal of a selected electric or electronic part or device, and a plurality of second lands each being contiguous to and extending outwards from the first land, and that the areas contiguous to the contours of the first and second lands have no conductive foils such as copper foils to expose the substrate surface of the printed circuit board.
2. A printed circuit board according to claim 1, wherein it further comprises narrow resist layers formed between the exposed areas and the first and second lands.
3. Soldering structure for soldering electric or electronic parts or devices to the circuit pattern of a printed circuit board comprising a plurality of composite lands each including a first land having a terminal hole made at its center for inserting the terminal of a selected electric or electronic part or device, and a plurality of second lands each being contiguous to and extending outwards from the first land, the areas contiguous to the contours of the first and second lands having no conductive foils such as copper foils to expose the substrate surface of the printed circuit board, wherein the solder lump joining the terminal of the part or device to the first land and its adjoining second lands may be shaped into a ribbed conical form having the terminal at its center and its outer ribs integrally connected to and projecting from the cone.